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IN THE CLAIMS:

1. *(currently amended)* An ~~anisotropically etched prism~~ light coupling assembly, comprising:

a device portion including a plurality of optical devices arranged in a first fixed pattern, ~~each pair of said plurality of said~~ optical devices spaced a first prescribed distance apart;

a light coupling portion including a plurality of anisotropically etched ~~prisms~~ coupling elements, ~~each one of the plurality of anisotropically etched prisms said coupling elements~~ arranged in second fixed pattern so as to correspond with a respective one of the plurality of optical devices, wherein ~~each one of the pairs of said plurality of anisotropically etched prisms are spaced a second prescribed distance apart, the second prescribed distance substantially equals the first prescribed distance, the light coupling portion is disposed in an aligned arrangement with the device portion;~~ and

~~an alignment portion that is used to align the light coupling portion and the device portion, wherein each one of said plurality of anisotropically etched prisms are aligned with a respective one of said plurality of optical devices.~~

2. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 1, further comprising a securing portion wherein each one of said plurality of anisotropically etched ~~prisms are~~ coupling elements is secured relative to a respective one of said plurality of optical devices as aligned.

3. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 2, wherein the securing portion includes material selected from the group consisting of an adhesive material and a bonding material.

4. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 1, wherein each one of the plurality of anisotropically etched ~~waveguide prisms~~ coupling elements and the respective one of the plurality of optical devices combine to form a hybrid active electronic and optical circuit including an active electronic device and at least one of the ~~plurality of~~ optical devices.

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5. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 4, wherein the hybrid active electronic and optical circuit comprises an input/output light coupler and an evanescent coupling region, wherein the input/output light coupler is associated with the at least one optical device, and wherein the evanescent coupling region is at least partially formed from a gap portion that couples the input/output light coupler to the at least one optical device using evanescent coupling.

6. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the evanescent coupling region includes a tapered gap portion.

7. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 6, wherein the tapered gap portion enhances coupling efficiency.

8. *cancelled*

9. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the evanescent coupling region is at least partially formed using an optically clear adhesive.

10. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 9, wherein the optically clear adhesive secures the input/output light coupler to the evanescent coupling region.

11. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the evanescent coupling region is at least partially formed from air.

12. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the at least one optical device includes an optical

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waveguide having an upper cladding, and the evanescent coupling region and the upper cladding are formed at least partially of the same material.

13. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 12, wherein evanescent coupling region and the upper cladding are at least partially formed of glass.

14. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 12, wherein the evanescent coupling region and the upper cladding are at least partially formed of a polyamide.

15. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 12, wherein the evanescent coupling region and the upper cladding are at least partially formed of an electric insulator.

16. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 15, wherein the electric insulator is also used to partially define active electronics in the hybrid active electronic and optical circuit.

17. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein altering an electric voltage applied to the active electronic device affects a free carrier distribution in a region of the at least one optical device, and thereby changes the effective mode index of the at least one optical device.

18. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 17, wherein the at least one optical device includes a waveguide.

19. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the evanescent coupling region is at least partially formed from an optically ~~clear~~ clear polymer.

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20. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein evanescent coupling region has a thickness of less than 0.5 μ m.

21. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 6, wherein the tapered gap portion supports a first edge of the input/output light coupler at a height that is less than 100 microns above a second edge of the input/output coupler.

22. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 21, wherein the second edge is in contact with a waveguide proximate the input/output coupler.

23. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 21, wherein the second edge is out of contact with a waveguide proximate the input/output coupler.

24. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 6, further comprising a ledge that supports the input/output light coupler above the tapered gap portion.

25. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 24, wherein the ledge has a height that is less than 50 microns.

26. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 25, wherein the ledge has a height of less than 3 microns.

27. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the input/output light coupler includes a waveguide prism.

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28. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 6, wherein the input/output light coupler includes a waveguide prism.

29. - 31. *cancelled*

32. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the input/output light coupler includes a waveguide grating.

33. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 6, wherein the input/output light coupler includes a waveguide grating.

34. - 36. *cancelled*

37. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the input/output light coupler is at least partially formed from a wafer disposed above the active electronic device and the at least one optical device.

38. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the hybrid active electronic and optical circuit includes a focusing mirror.

39. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the input/output coupler couples light into or out of a waveguide.

40. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the hybrid active electronic and optical circuit includes a Fabry-Perot cavity.

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41. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the hybrid active electronic and optical circuit includes a wavelength division multiplexer modulator.

42. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the hybrid active electronic and optical circuit includes an evanescent coupler.

43. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the hybrid active electronic and optical circuit includes a diode.

44. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 5, wherein the hybrid active electronic and optical circuit includes a transistor.

45. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 1, wherein each anisotropically etched ~~waveguide prism coupling element~~ is a KOH etched waveguide prism.

46. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 1, wherein the device portion includes a silicon on insulator (SOI) flip chip portion.

47. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 1, wherein the light coupling portion includes an optical/electronic I/O flip chip portion.

48. *(currently amended)* The ~~anisotropically etched prism~~ light coupling assembly of claim 1, further comprising an AWG.

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49. *(currently amended)* The ~~anisotropically etched prism light coupling~~ assembly of claim 1, further comprising at least one evanescent coupling region associated with each of the plurality of anisotropically etched ~~light coupling portions~~ coupling elements, one of the at least one evanescent coupling regions extending ~~between~~ under at least one of said plurality of anisotropically etched light coupling portions elements and attached to at least one of the plurality of optical devices.

50. *(currently amended)* The ~~anisotropically etched prism light coupling~~ assembly of claim 49, wherein at least one evanescent coupling region is at least partially configured as a gap portion.

51. *(currently amended)* The ~~anisotropically etched prism light coupling~~ assembly of claim 50, wherein the at least one evanescent coupling region includes a tapered gap portion.

52. *(currently amended)* The ~~anisotropically etched prism light coupling~~ assembly of claim 1, wherein the ~~anisotropically etched prism light coupling~~ assembly includes one from the group of a p-n device, a field plated device, a Schottky device, a MOSCAP, and a MOSFET.

53. *(currently amended)* An ~~etched light coupling portion~~ assembly, comprising:
a device portion including a plurality of optical devices arranged in a first fixed pattern, each pair of said plurality of optical devices spaced by a first prescribed spacing;
a light coupling portion wafer including a plurality of etched light coupling ~~elements~~ portions, each one of the plurality of etched light coupling ~~portions~~ elements arranged in a second fixed pattern ~~so as to correspond with a respective one of the plurality of optical devices, wherein each one of the pairs of said plurality of etched light coupling portions are spaced by a second prescribed spacing, the second prescribed spacing substantially equals the first prescribed spacing~~ such that the etched light coupling elements are disposed in an aligned arrangement with respective ones of the optical devices; and

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~~an alignment portion that is used to align the light coupling portion wafer and the device portion, wherein each one of said plurality of etched light coupling portions are aligned with a respect one of said plurality of optical devices.~~

54. *(currently amended)* The etched light coupling ~~portion~~ assembly of claim 53, further comprising a securing portion wherein each of said plurality of etched light coupling ~~portions~~ elements are secured relative to a respective one of said plurality of optical devices as aligned.

55. *(currently amended)* The etched light coupling portion assembly of claim 54, wherein the securing portion includes one from the group of an adhesive or a bonding bond.

56. *(currently amended)* A method of etching a light coupling ~~portion~~ assembly, comprising:

etching a device portion including a plurality of optical devices arranged in a first fixed pattern, wherein each ~~pair~~ of said plurality of optical devices is spaced by a first prescribed spacing;

etching a light coupling portion wafer including a plurality of etched light coupling ~~portions~~ elements, wherein each one of the plurality of etched light coupling ~~portions~~ are elements is arranged in a second fixed pattern so as to correspond with a respective one of the plurality of optical devices, and wherein each one of ~~the pairs of~~ said plurality of etched light coupling ~~portions~~ are elements is spaced by a second prescribed spacing, the second prescribed spacing substantially ~~equals~~ equaling the first prescribed spacing; and

aligning the light coupling portion wafer and the device portion, wherein each one of said plurality of etched light coupling ~~portions~~ are elements is aligned with a respective one of said plurality of optical devices.

57. *(new)* The light coupling assembly as defined in claim 2 wherein the securing portion includes an atomic bonding of the device portion to the light coupling portion.

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58. *(new)* The light coupling portion assembly as defined in claim 53 wherein the light coupling portion wafer includes an evanescent coupling region.